

SECA Core Technology Program R&D at PNNL

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Pittsburgh, PA

Objective



- ▶ Provide R&D support to SECA program
 - Development/evaluation of improved materials and fabrication processes for SOFC cells and stacks
 - Improved understanding of performance degradation mechanisms
 - Development/implementation of modeling tools to facilitate cell and stack design and optimization
 - Technology transfer to industry teams

Technology Transfer Process

- ▶ **First step:** Testing and characterization at sub-stack level
 - Materials Characterization
 - XRD, SEM, EDS, TEM, XPS, TGA, DSC, PSA, dilatometry, electrical conductivity, single & dual atmosphere oxidation
 - Multiple Component Tests
 - Button cell testing
 - ASR testing of interconnect/cathode contact/cathode structures
 - Electrical testing and leak testing of seal/interconnect and cell/seal/interconnect structures

- ▶ **Second step:** Testing under realistic “stack-like” conditions to bridge the gap between small-scale tests (e.g., button cells) and SECA industry team stacks

Technology Transfer Process

▶ SECA CTP Stack Test Fixture

■ Advantages:

- Can evaluate/validate new materials and fabrication processes under more realistic conditions
- Larger cell size than button cells (50mm x 50mm)
- Complete stack functionality (cell, cell frame, seals, interconnects, electrical contact materials)

■ Challenges:

- Increased complexity (and cost) of assembly, co-fabrication of seals and electrical contact materials
- Multiple components & phenomena, so results can be more difficult to interpret

- Note: PNNL has transferred fixture design and test protocols to other SECA CTP participants (NETL, U. Conn.)

▶ Final step:

- **Delivery of topical reports**
- **Delivery of materials to SECA industry teams for in-house evaluation**



Scope of Work

- ▶ **Determined through consultation with NETL program management and SECA industry teams**
 - Increased communication with industry teams in past year

- ▶ **Current areas of emphasis**
 - SOFC interconnects
 - Alloys and coatings for IT-SOFC, Ceramic interconnects
 - Seals for SOFC stacks
 - Devitrifying glass seals, Compliant glass seals
 - Cathode materials and interactions
 - In-situ XRD characterization, Effects of humidity
 - Anode materials and interactions
 - Effects of high fuel utilization, Mitigation of sulfur poisoning
 - Modeling
 - 2D and 3D modeling tools to assist in cell/stack design
 - Modeling of cell/stack degradation processes

Seal Development

■ Devitrifying Glass Seals

- A series of devitrifying glass seals with sealing temperatures between 825 and 1000°C have been developed.
 - ◆ Good CTE match to other components
 - ◆ Rapid stabilization of dimensions and microstructure due to devitrification
 - ◆ Good bonding to YSZ and interconnects (with aluminization of steel surface)
 - ▶ Reactive air aluminization process developed at PNNL
- **Current work focused on improved wetting/flow behavior at sealing temperatures $\geq 950^{\circ}\text{C}$**

■ “Compliant” glass seals also under development

- ◆ Collaboration with ORNL
- ◆ Potential advantages: reduction of thermal stresses, self-healing behavior
- ◆ Potential challenges: crystallization, reactivity, and containment

■ Poster Presentation

- **Glass Seal Development at Pacific Northwest National Laboratory**

Cathodes

■ Current Priorities:

- Investigating degradation mechanisms
 - ◆ *In-situ* high temperature XRD of operating LSCF cathodes
 - ◆ 700, 750, and 800°C
- Effects of air humidity on cell performance
 - ◆ LSCF and LSM/YSZ cathodes
 - ◆ Dry air vs. 3% H_2O

■ Poster Presentations

- Effects of Humidity in Cathode Air on LSM-YSZ Cathodes
- Extended Duration (1000 h) *In-situ* XRD of Operating LSCF Cathodes

Anodes

- ▶ **Effects of high steam content (high fuel utilization) on Ni-YSZ anodes**
 - Test anode-supported button cells with Ni/YSZ anodes and LSM/YSZ cathodes
 - Test conditions
 - 700°C, 800°C, 900°C
 - Constant current corresponding to 0.7 or 0.8 V
 - Fuel is a simulated coal gas
 - Fuel humidity corresponding to various fuel utilizations achieved by adding oxygen
 - Include “control” cells held at low fuel utilization
 - **Ac and dc electrochemical measurements of each cell**
 - **Monitor temperature of each individual cell**
 - **Post-test characterization using SEM/EDS, TEM, and EBSD**

- ▶ **Poster Presentation**
 - **Durability of Nickel/Zirconia Anodes in SOFCs at High Fuel Utilization**

Alloy Interconnects and Protective Coatings

- ▶ Primary emphasis is on AISI 441 w/ Ce-modified MnCo spinel (MC) protective coating. Current activities:
 - Long-term evaluation of oxidation resistance and electrical performance
 - Effects of alloy surface treatments on oxidation behavior, spallation resistance are under investigation (collaboration with Allegheny Ludlum)
 - Optimization of ultrasonic spray fabrication process: coating uniformity and thickness
 - **Poster presentation**
 - ◆ **The Effect of Spinel Coating Thickness on SOFC Interconnect Resistance**
- ▶ Investigation of alternative coating compositions (e.g., oxides with reduced Co content, aluminization)

Low-cost Alloy-based Interconnects

▶ Interconnect Alloy: AISI 441

- Ferritic stainless steel: Good CTE match to other components; Electrically conductive Cr-based oxide scale
- Inexpensive - Manufactured via conventional melt metallurgy
- Similar to AISI 430, but additions of Nb and Ti improve high temperature strength and prevent formation of insulating SiO₂ layer at alloy/scale interface
- Similar to all other FSS, relatively high oxidation rate at SOFC operating temperatures (and volatility of Cr) indicates need for protective coating
- Also, relatively weak scale adherence (no RE in alloy)

▶ Interconnect Coating: Ce-modified (Mn_{0.5}Co_{0.5})₃O₄ Spinel

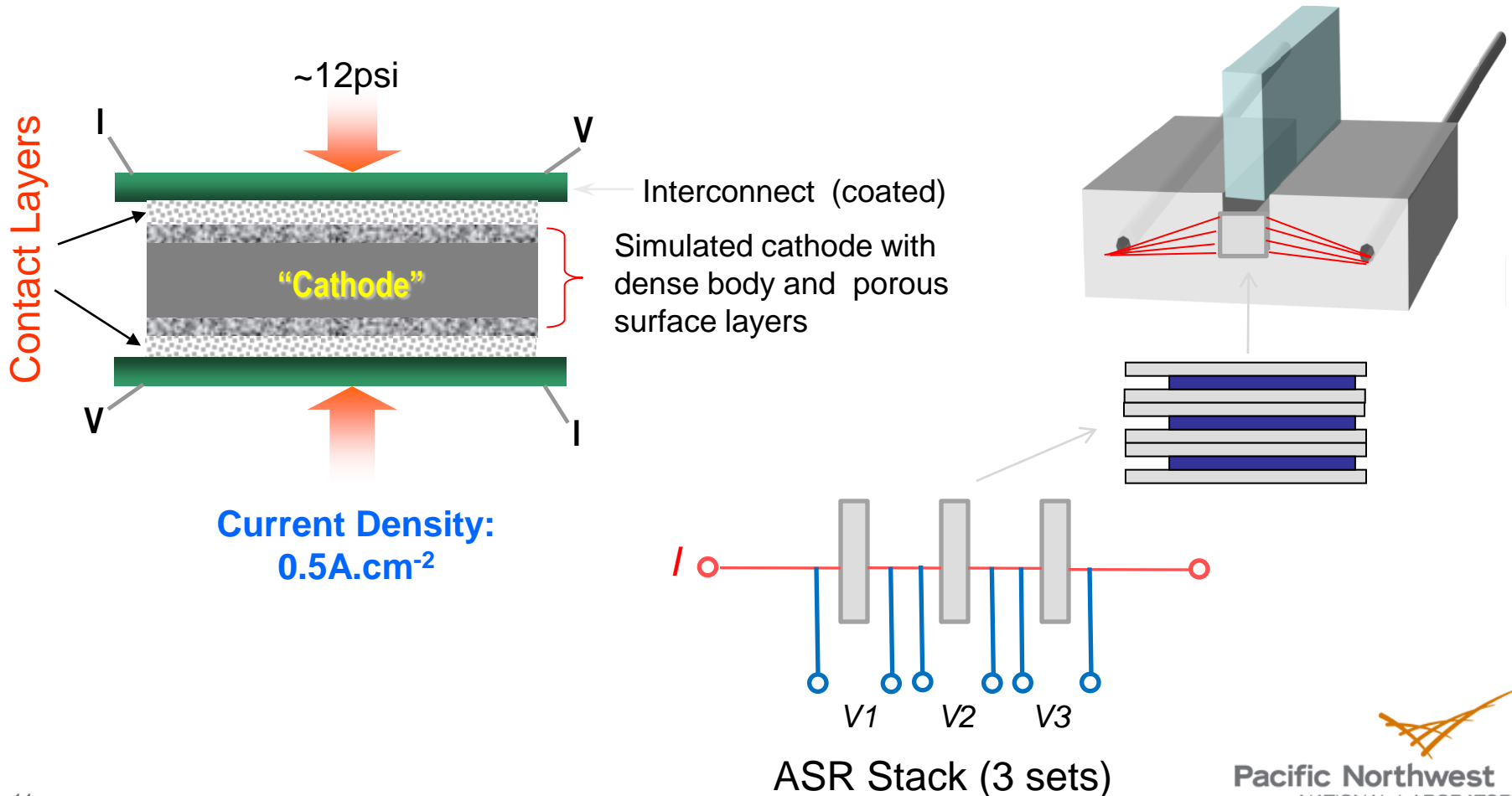
- High electrical conductivity (~60 S/cm), good CTE match (~11 ppm/K)
- Ceria inclusions improve oxide scale adherence
- Coating improves oxidation resistance and mitigates Cr volatility

k_p (g ² /cm ⁴ -s)	800°C	850°C
Ce-MC coated 441	2×10^{-14}	1×10^{-13}
Bare 441	5×10^{-14}	3×10^{-13}

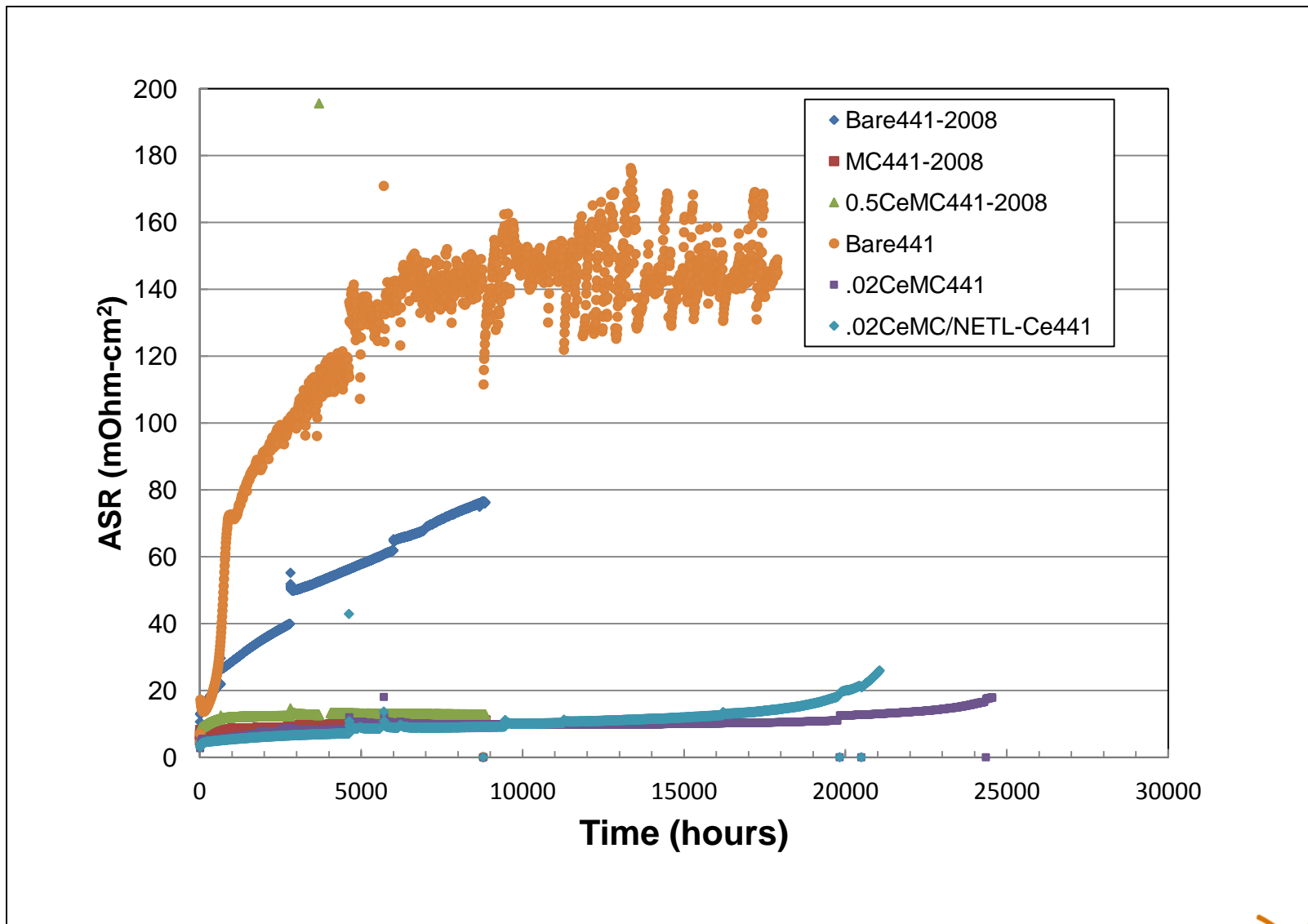


Area Specific Resistance (ASR) Measurements

$$ASR_{cathode-interconnect} = \Phi(\text{scale, contact material, coatings})$$

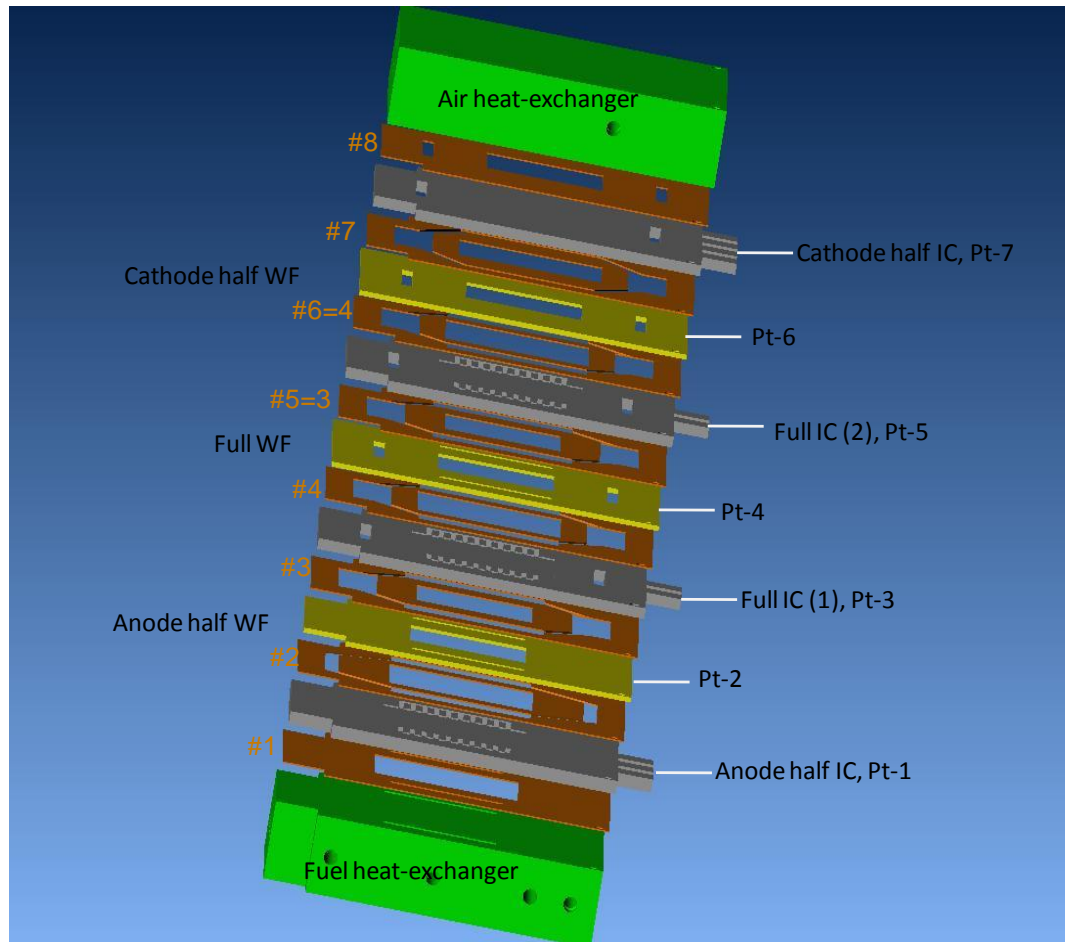


Long-Term ASR measurements: 800°C



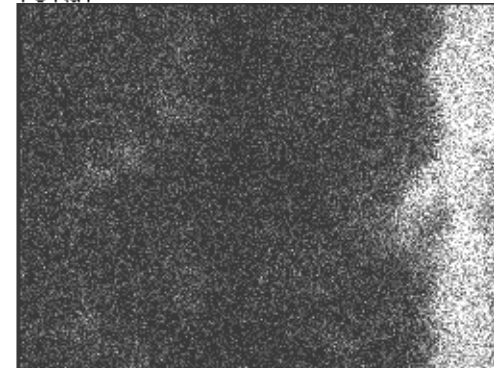
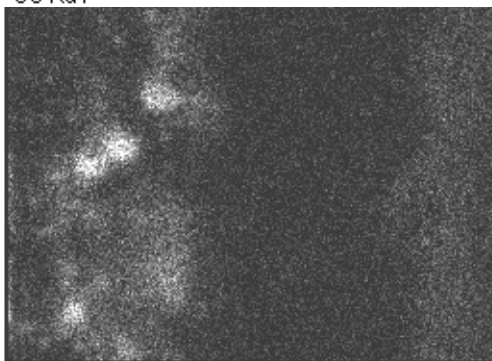
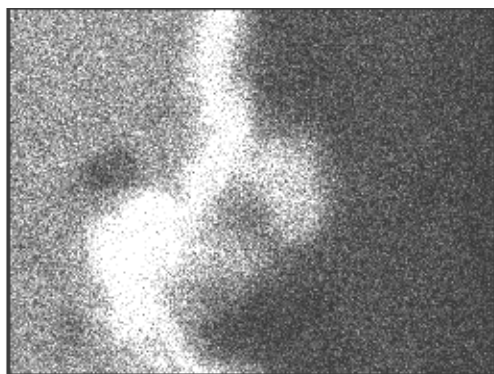
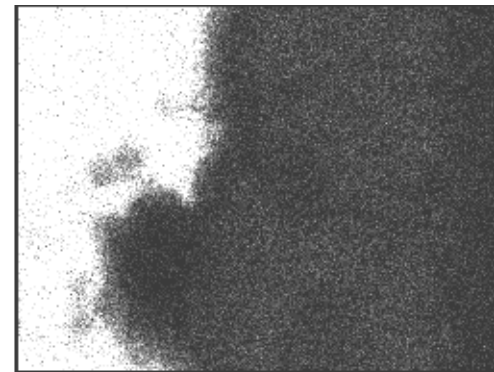
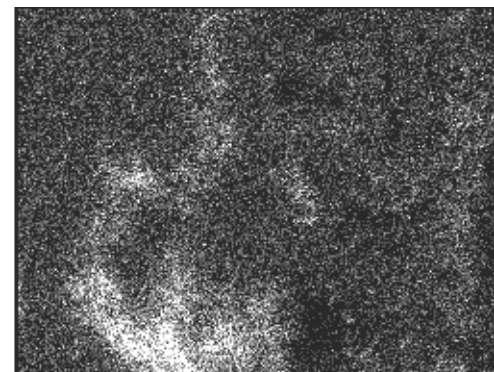
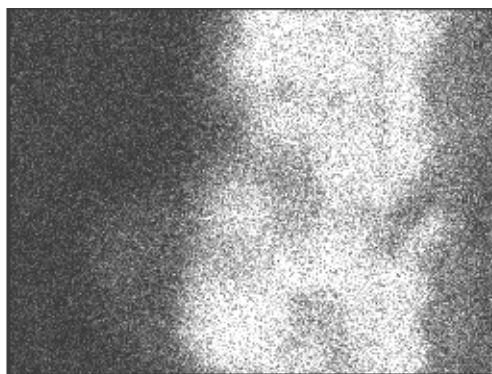
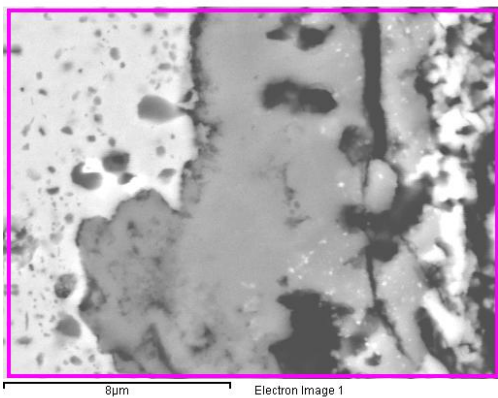
Long-term testing of Ce-MC spinel-coated AISI 441

- ▶ 6,000 hour test under stack-like conditions (SECA CTP stack test fixture)
- ▶ 800°C; air vs. moist H₂/N₂

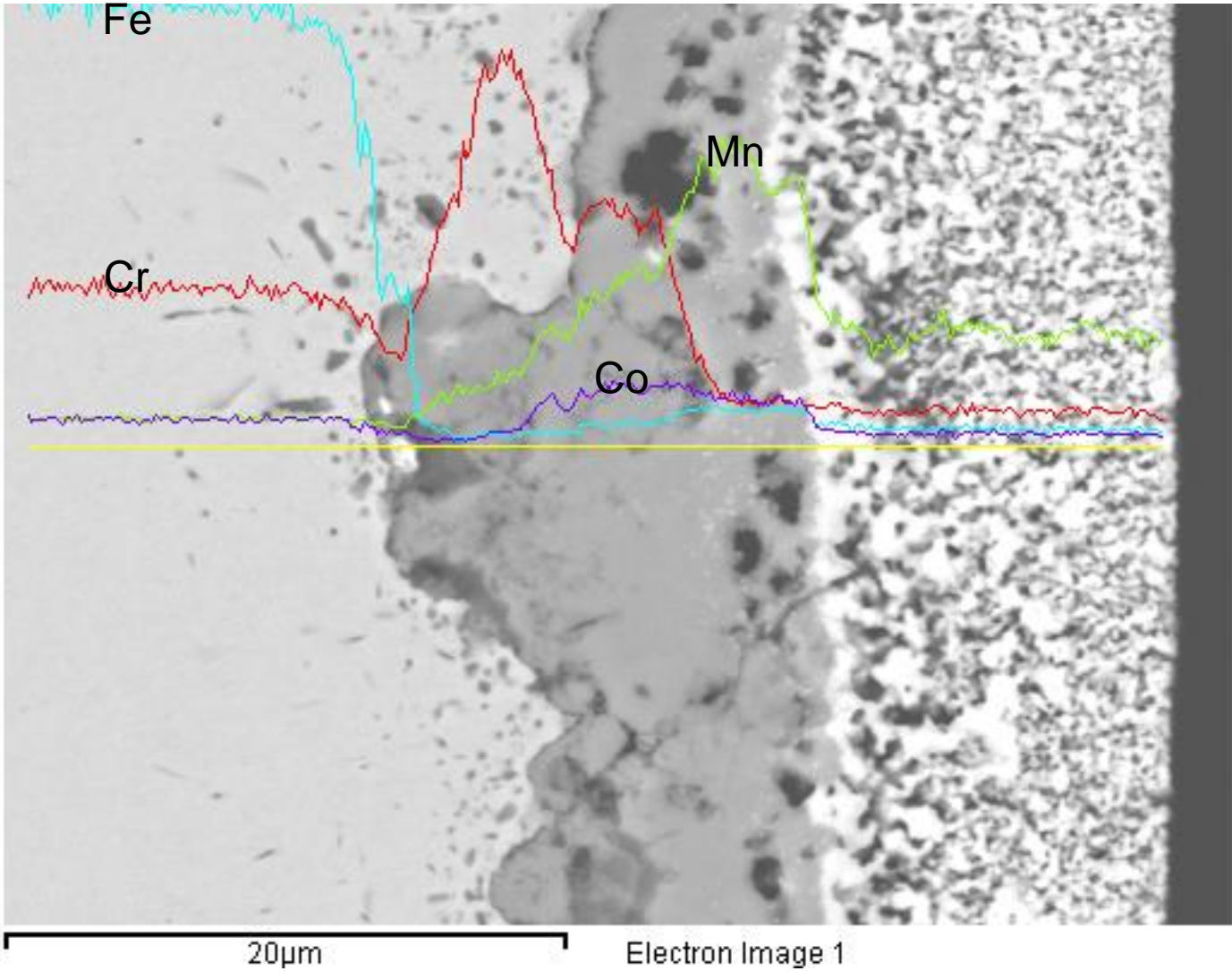


Poster Presentation:
“Recent Progress in
SOFC Stack Test Fixture
Development and
Materials Validation at
PNNL”

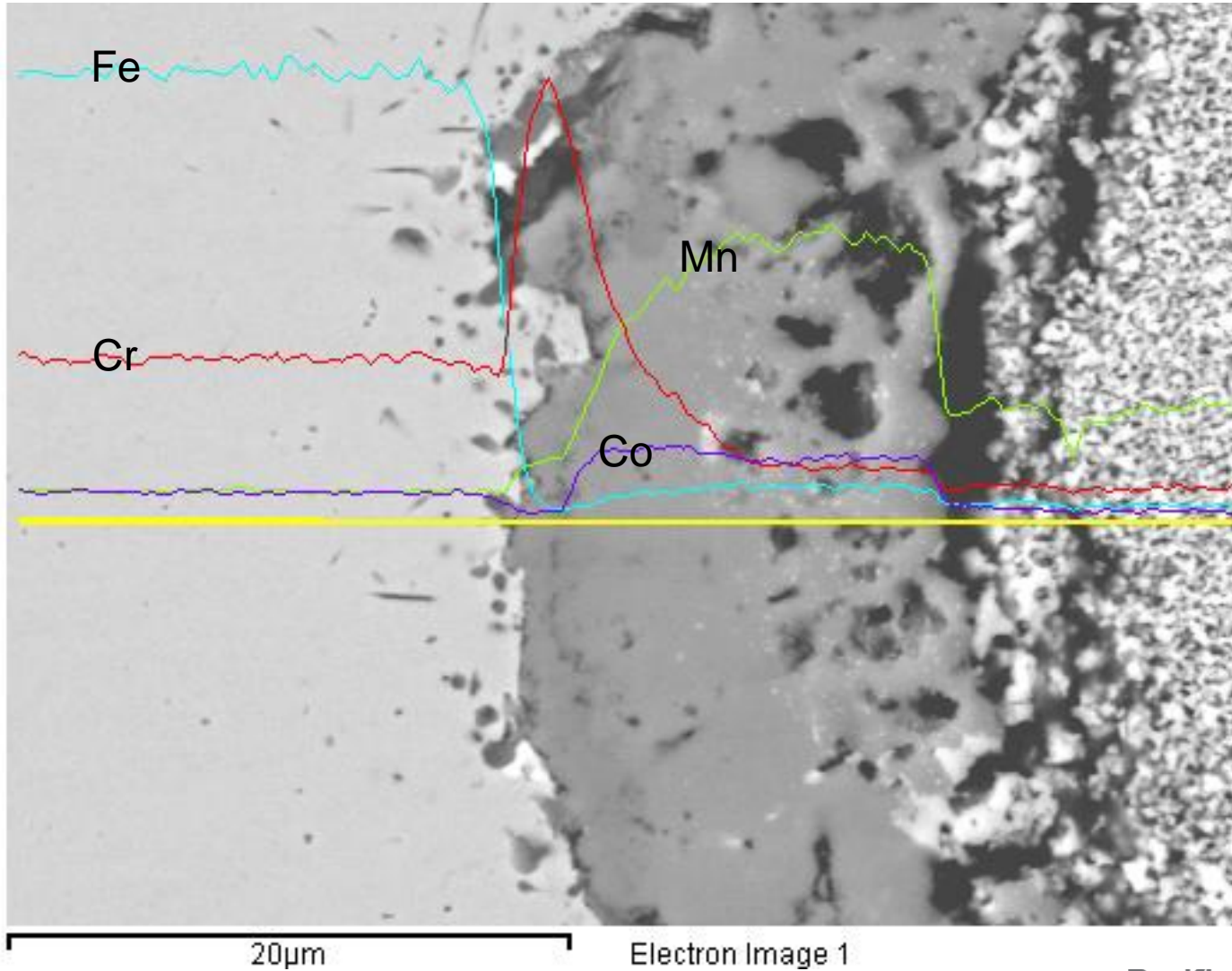
Spinel-coated cathode IC and LSM contact interface



Spinel-coated cathode IC and LSM contact interface



Spinel-coated cathode IC and LSM contact interface



Surface Modifications to AISI 441

- Goal: Improve long-term scale adhesion under spinel coating
- Provided by Allegheny Ludlum:
 - 1. Mill reference (as would be provided to a customer without any additional modifications)
 - 2. Desiliconized (treatment to sequester silicon from the near surface of the sheet; an alternative to decreasing Si content of alloy)
 - 3. Surface blasted (abrasion/peening resulting in surface deformation)
 - 4. Surface ground (rough surface abrasion resulting in surface deformation)
 - 5. Temper rolled (cold rolling process resulting in through-thickness deformation)
- 0.020" thick coupons coated with Ce-MnCo spinel, heat-treated in air at 800 or 850°C; 16 coupons for each condition

Effect of Surface Condition on Oxidation/Spallation Behavior of Spinel-coated 441: 800°C

Time (h)	Mill Reference (1200 grit)	Temper Rolled		De-siliconized		Surface Grind		Surface Blast	
		Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding
2000									
4000	X								
6000	X			C	X				
8000	X			C					
10000	XX			C					
12000	XX					X	L		
14000	XX					L			
16000	XX								
18000	XX								

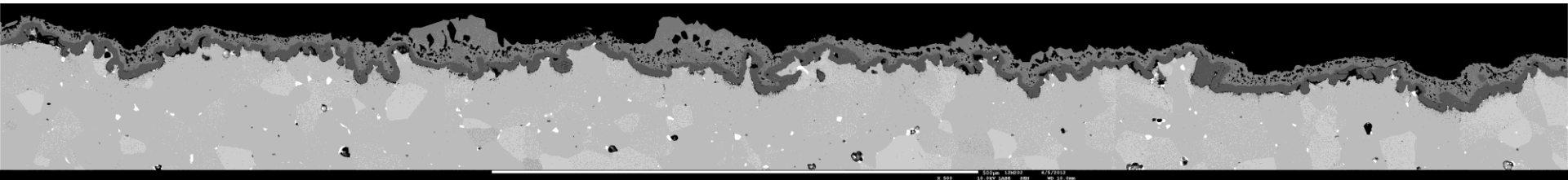
X - spallation on at least one coupon

XX - no unspalled coupons left in study

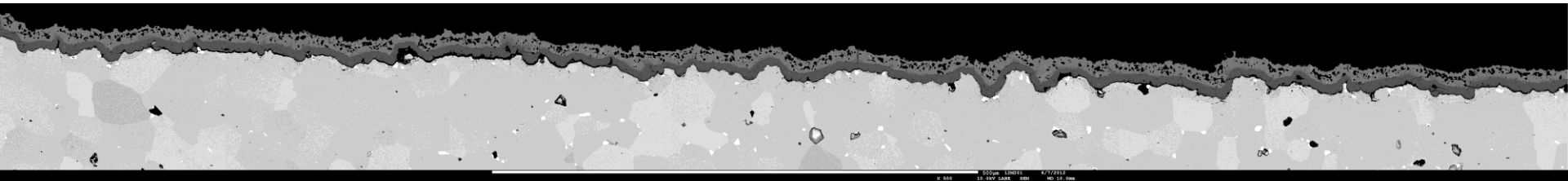
C - complete de-bonding of scale of SEM/EDS sample

L - localized de-bonding of scale of SEM/EDS sample

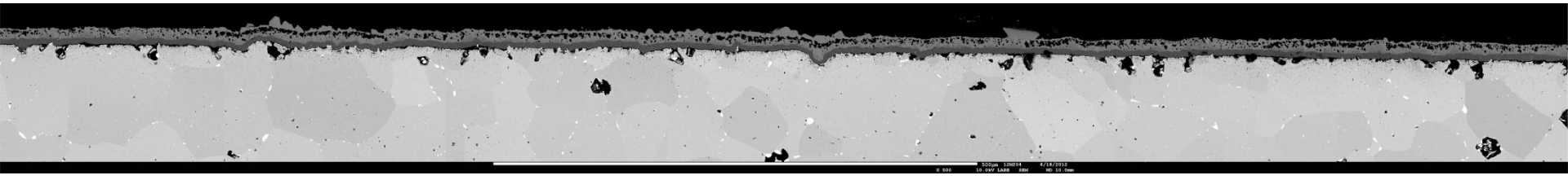
18000 h, 800°C in Air



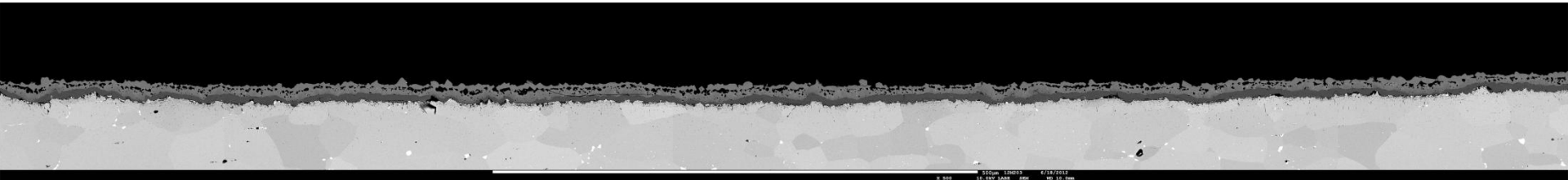
▶ Surface Blast



▶ Surface Ground

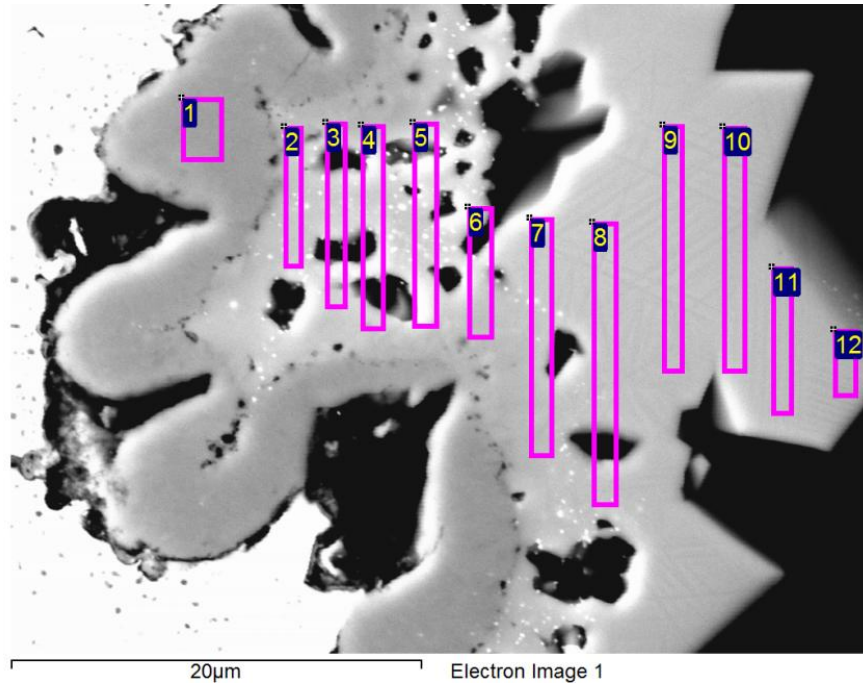


▶ De-siliconized



▶ 50% Cold Rolled

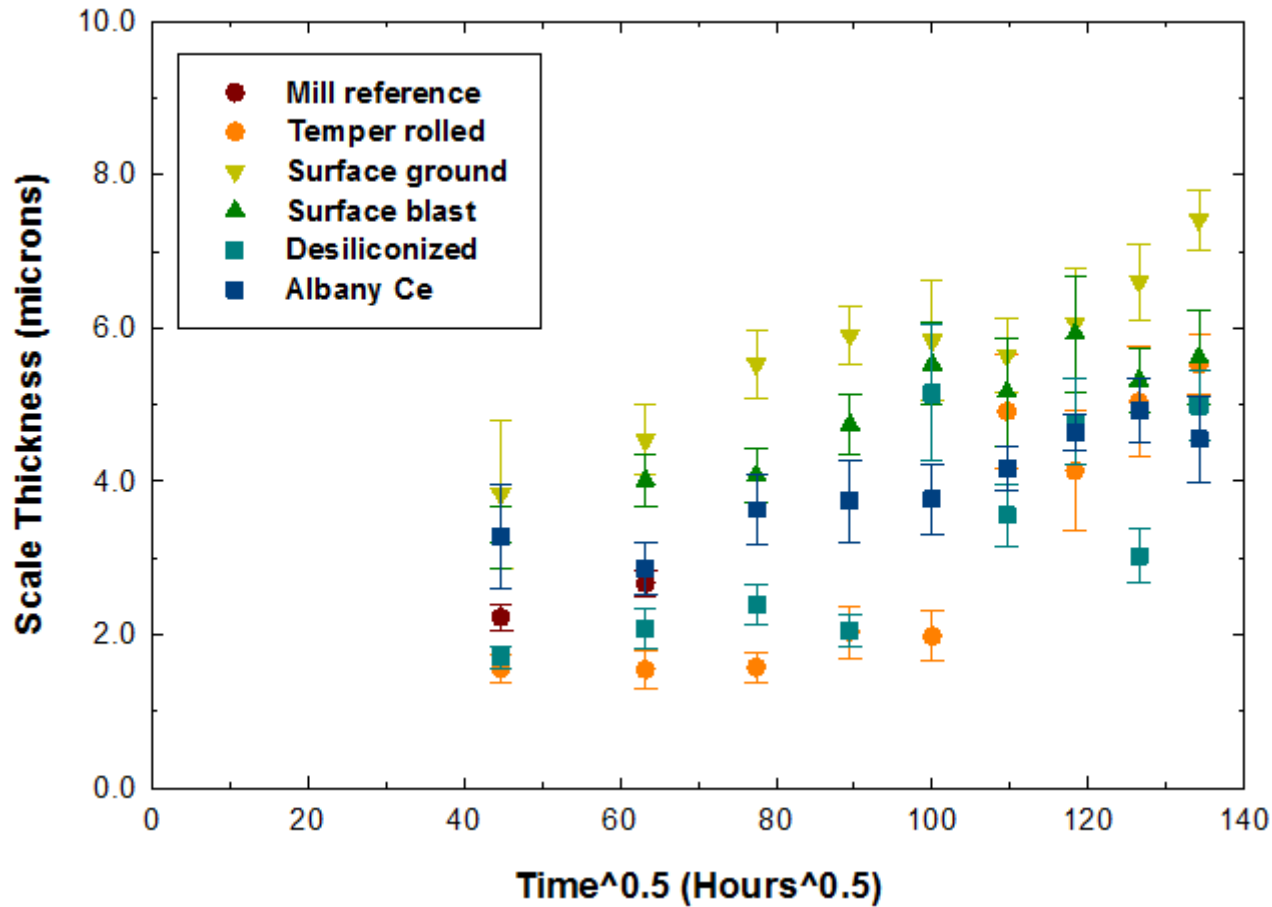
Surface Blasted AISI 441 w/ Ce-modified MnCo Spinel coating: 18,000 hours, 800°C, air



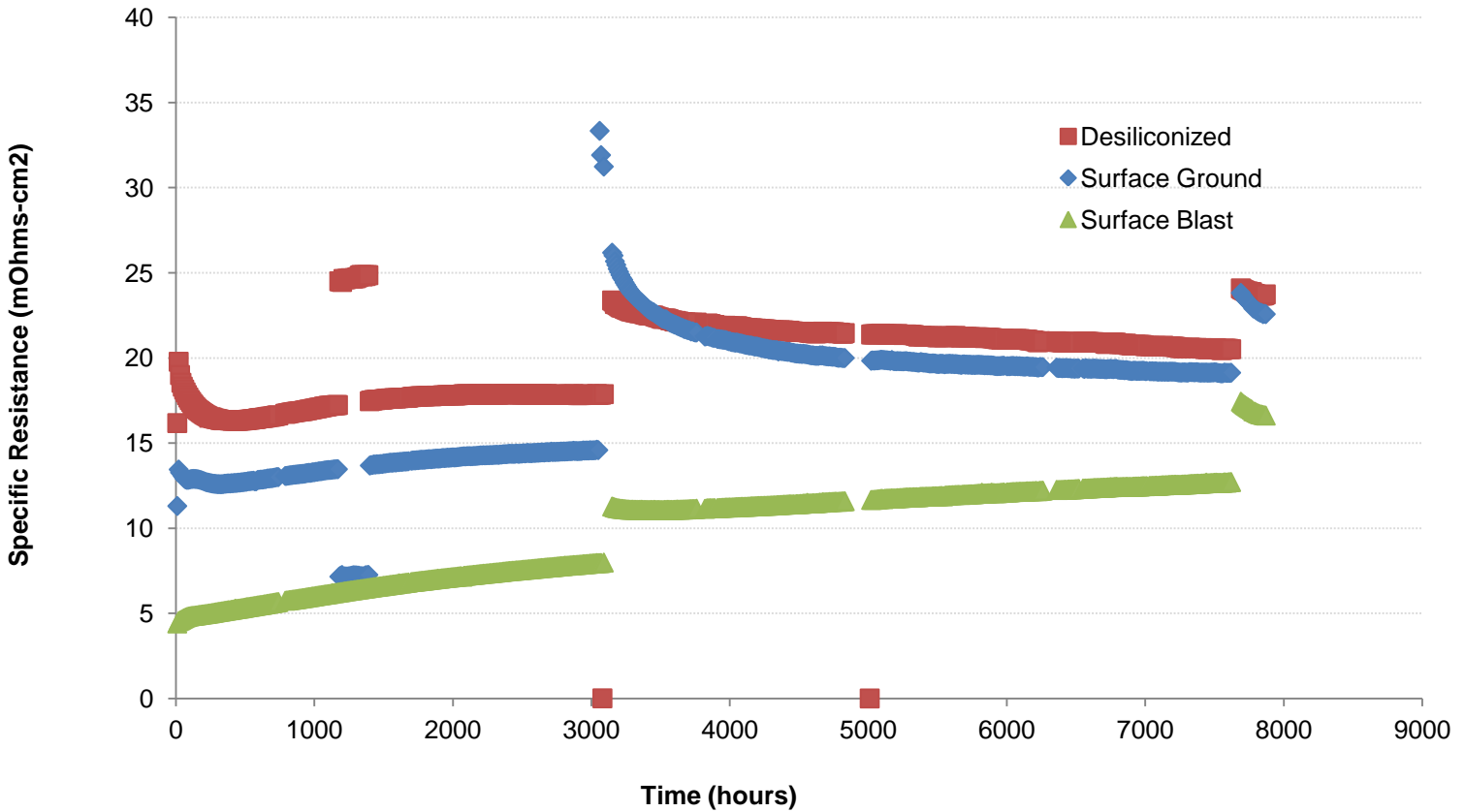
Spectrum	O	Si	Ti	Cr	Mn	Fe	Co	Ce
1	66.15		0.25	32.66	0.69	0.26		
2	60.09		0.37	9.57	14.46	3.36	12.15	
3	57.78		0.47	5.55	18.04	4.10	13.68	0.38
4	58.25		0.41	4.64	18.37	4.10	13.82	0.41
5	60.12		0.33	4.15	17.51	4.09	13.47	0.34
6	59.95		0.26	4.87	17.40	3.97	13.55	
7	60.56		0.19	4.59	17.33	3.95	13.38	
8	59.99	0.28	0.23	2.39	19.27	4.38	13.47	
9	59.43		0.21	2.14	19.83	4.52	13.86	
10	59.12			3.26	19.26	4.40	13.96	
11	58.84			4.06	18.75	4.33	14.03	
12	58.75			4.19	18.74	4.28	14.04	

Atomic%

Surface Treated AISI 441 w/ Ce-modified MnCo spinel coating; 800°C



ASR Results for Surface Treated AISI441 (LSCF cathode and contact, Ce-MC 441)



Effect of Surface Condition on Oxidation/Spallation Behavior of Spinel-coated 441: 850°C

Time (h)	Mill Reference (1200 grit)	Temper Rolled		De-siliconized		Surface Grind		Surface Blast	
		Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding	Macroscopic Spallation	Microscopic De-bonding
2000									
4000									
6000		C							
8000		C			C				
10000	X		X		C				
12000	X		X		X				#

X - spallation on at least one coupon

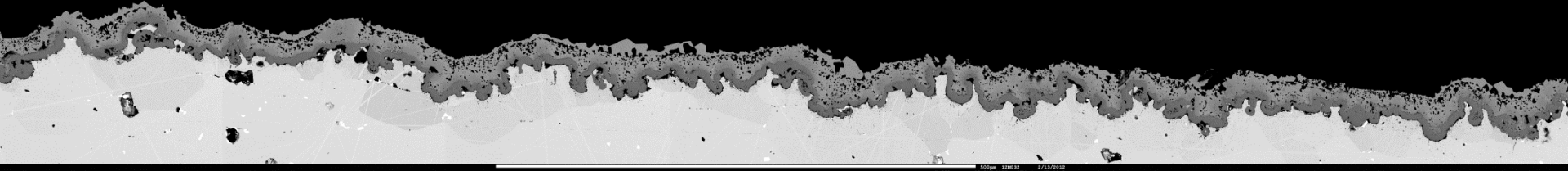
XX - no unspalled coupons left in study

C - complete de-bonding of scale of SEM/EDS sample

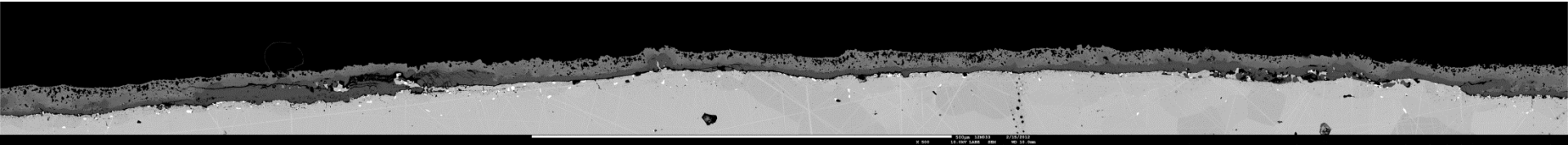
L - localized de-bonding of scale of SEM/EDS sample

- coupon not removed for analysis due to limited # of coupons

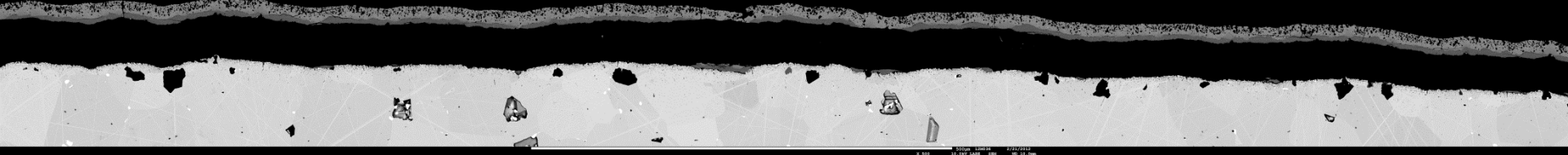
10000 h, 850°C in Air



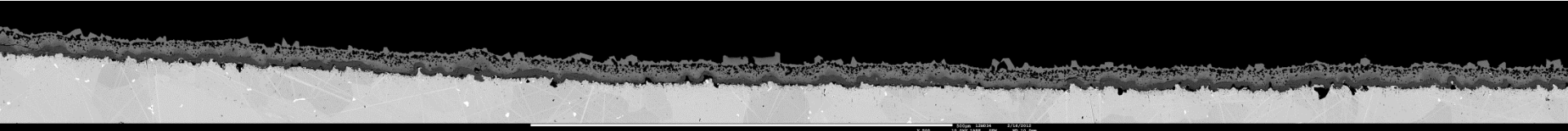
▶ Surface Blast



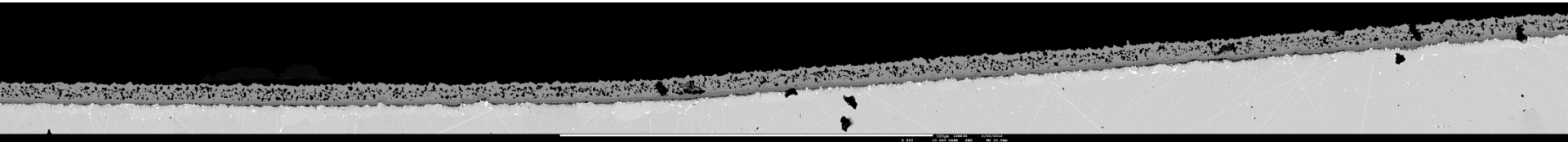
▶ Surface Ground



▶ De-siliconized

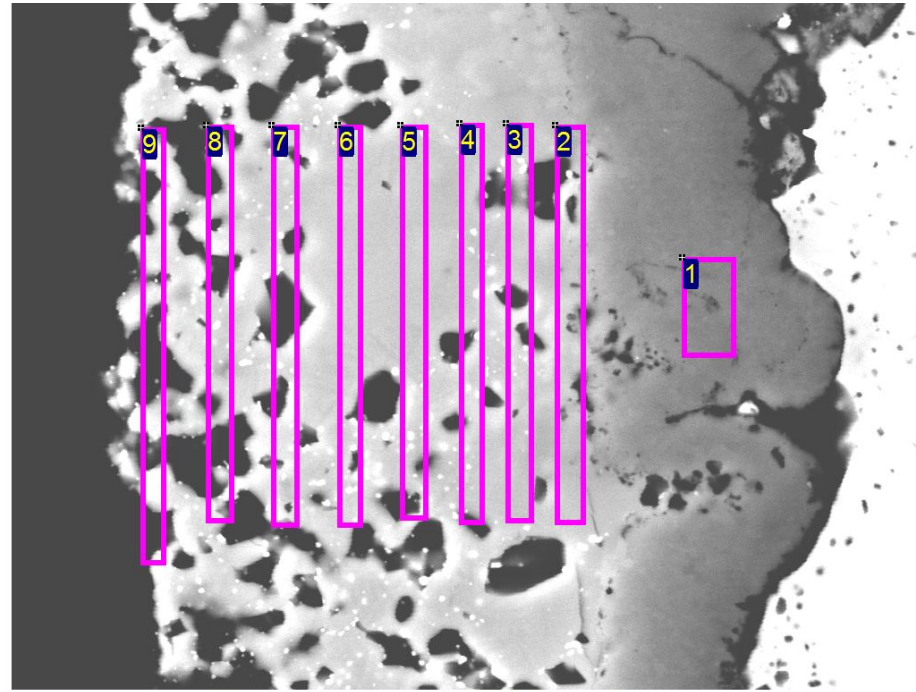


▶ 50% Cold Rolled



▶ Mill Reference (1200 grit)

Surface Blasted AISI 441 w/ Ce-modified MnCo Spinel coating: 10,000 hours, 850°C, air



20µm Electron Image 1

Spectrum	In stats.	O	Si	Ti	Cr	Mn	Fe	Co	Ce
1	Yes	64.99	0.49	0.78	33.58		0.16		
2	Yes	63.67	0.96	0.22	16.91	7.61	0.86	9.77	
3	Yes	62.05	1.01	0.27	8.28	14.05	1.75	12.59	
4	Yes	62.12	0.71	0.32	5.67	16.17	1.87	12.85	0.30
5	Yes	62.19		0.31	5.68	16.47	1.91	13.20	0.24
6	Yes	62.18		0.31	4.67	17.43	1.83	13.58	
7	Yes	59.57	0.71	0.31	3.75	19.06	2.11	14.15	0.34
8	Yes	59.72		0.32	3.49	19.39	2.14	14.59	0.36
9	Yes	58.86		0.26	3.69	19.48	2.27	14.95	0.50
Max.		64.99	1.01	0.78	33.58	19.48	2.27	14.95	0.50
Min.		58.86	0.49	0.22	3.49	7.61	0.16	9.77	0.24

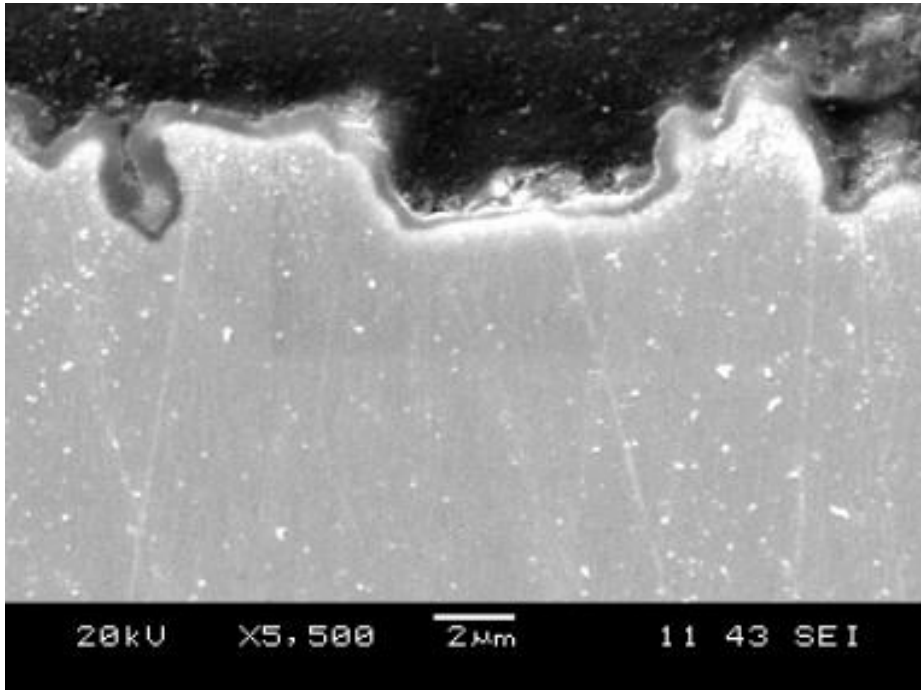
Atomic%



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Reactive Air Aluminization (RAA)

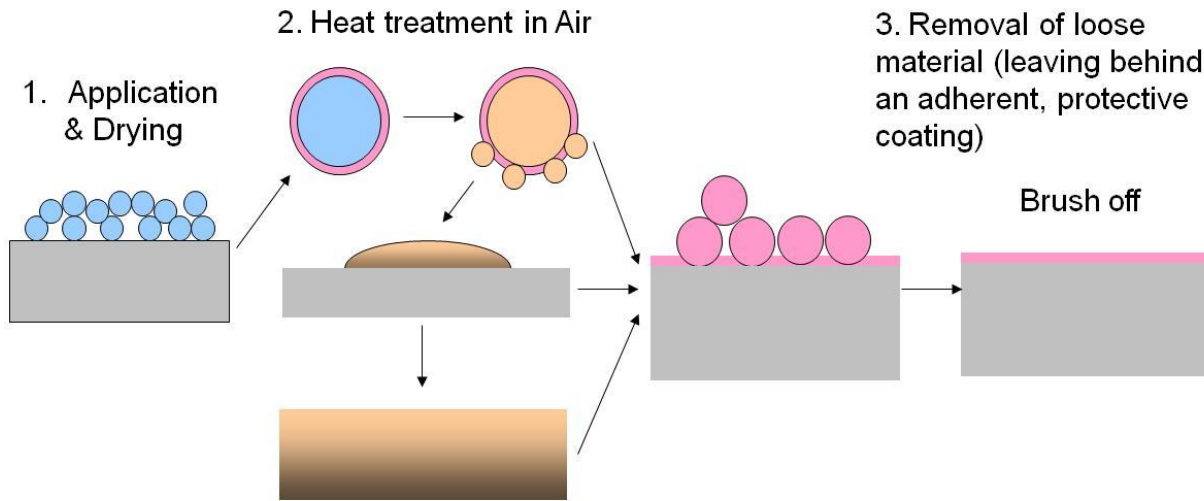
- Reaction between alkaline earths in glass seals and Cr in interconnect steel can form high CTE chromate phases (e.g., SrCrO_4), which degrade interfacial strength
- Cr volatility from alloys can poison cathodes
- Reactive Air Aluminization (RAA) offers a simple alternative to controlled atmosphere aluminization of interconnects and BOP components



**Report on RAA
distributed to industry
teams in October, 2011**

**Samples aluminized
and delivered to
industry teams for
evaluation**

Reactive Air Aluminizing



- Aluminum powder slurry-based process
- Heat treatment in air
 - 3°C/min to 1000°C
 - 1 hour dwell at 1000°C
 - 3°C/min cooldown

Perovskite Interconnects

▶ Candidate Compositions

■ Yttrium chromite

- More stable towards water and YSZ than lanthanum chromite

- $\text{Y}_{0.8}\text{Ca}_{0.2}\text{Cr}_{0.9}\text{Ni}_{0.1}\text{O}_3$

- ◆ CTE = 11 ppm/K
- ◆ Conductivity in reducing atm: ~5 S/cm
- ◆ Low chemical expansion: 0.06 at 900°C

■ Lanthanum chromite

- $\text{La}_{0.78}\text{Sr}_{0.2}\text{CrO}_3$

- ◆ CTE = 11.1 ppm/K
- ◆ Low chemical expansion: 0.07 at 900°C
- ◆ More stable towards reduction (no Ni, Co, or Cu)?

▶ Previously demonstrated densification under constrained conditions

- Multiple liquid infiltrations/heat treatments required

▶ Two current approaches to enhance sintering under constrained conditions

- Both involve formation of final perovskite phase during sintering process

- Reaction sintering approach (enthalpy of reaction)
- Sintering aid approach (liquid phase assistance + enthalpy of reaction)

Summary

- ▶ AISI 441 w/ Ce-modified MnCo spinel coatings exhibits low, stable ASR in long-term testing
 - Less than $20 \text{ m}\Omega\text{-cm}^2$ after 25,000 hours at 800°C in air
- ▶ Surface-modified AISI 441 w/ Ce-modified MnCo spinel coatings exhibits improved long-term spallation resistance
 - 18,000 hours at 800°C (tests in progress)
 - 12,000 hours at 850°C (tests in progress)
- ▶ Future work:
 - Continue long-term testing of surface-modified AISI 441
 - Quantify relationship between surface morphology and oxidation resistance/scale adhesion
 - Prediction/Extension of IC lifetime



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